

Dear Customer,

Please find attached our INFINEON Technologies PCN:

## Introduction of TONGFU MICROELECTRONICS as alternate assembly site for TO220 MOSFET Products

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **18-November-2017**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**”, which stipulates:  
“**Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change.**”

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG  
Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0  
Chairman of the Supervisory Board: Wolfgang Mayrhober  
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck  
Registered Office: Neubiberg Commercial Register  
Amtsgericht München HRB 126492

**Introduction of TONGFU MICROELECTRONICS as alternate assembly site for TO220 MOSFET Products**

► **Products affected:**

See attached for affected parts.

► **Detailed Change Information:**

**Subject:** Qualification of TFME (Nantong, China) as alternate assembly site for TO-220 MOSFET products.

**Reason:** Expansion of assembly production to assure continuity of supply and enable flexible manufacturing.

**Description:** Introduction of TONGFU MICROELECTRONICS as alternate assembly site for TO220 MOSFET Products

**TO-220 MOSFET**

	<u>OLD</u>	<u>NEW</u>
<b>Assembly Site Location</b>	Great Team Backend Foundry (China), ASEW (China), PSIL (Philippines) and SP Semiconductors (Korea)	Great Team Backend Foundry (China), ASEW (China), PSIL (Philippines) and SP Semiconductors (Korea) and TFME
<b>Leadframe</b>	Bare copper	Selective Nickel Copper
<b>POD</b>	Differences identified in attachment-Customer Information Package	Differences identified in attachment-Customer Information Package

► **Product Identification:** Factory code marking is "J"(Section 4.4) , see attachment-Customer Information Package.

► **Impact of Change:** No impact is expected. The alternate assembly site will meet the same qualification level and POD specification as the existing assembly sites.

► **Attachments:** 1295-DISTI42-C4002348-AffectedParts.xlsx

► **Time Schedule:**

- Final qualification report: Available
- First samples available: Upon request
- Intended start of delivery: 30-November-2017

If you have any questions, please do not hesitate to contact your local Sales office.

Sales Name	SP number	OPN	Package
IRF2204PBF	SP001576552	IRF2204PBF	TO220
IRF3808PBF	SP001563250	IRF3808PBF	TO220
IRF8010PBF	SP001575444	IRF8010PBF	TO220
IRFB4110GPBF	SP001556050	IRFB4110GPBF	TO220
IRFB4115PBF	SP001565902	IRFB4115PBF	TO220
IRFB5620PBF	SP001565852	IRFB5620PBF	TO220
IRL1404PBF	SP001578568	IRL1404PBF	TO220
IRLB3036PBF	SP001568396	IRLB3036PBF	TO220
IRLB4030PBF	SP001552594	IRLB4030PBF	TO220
IRLB8314PBF	SP001572766	IRLB8314PBF	TO220
IRF200B211	SP001561622	IRF200B211	TO220
IRF60B217	SP001571396	IRF60B217	TO220